

ABSTRACT OF THE DISCLOSURE

A method for testing soldering quality is provided for determining the solder quality of pins, leads, a connector or an electronic component mounted on a circuit board. A soldering contact, soldered to the circuit board, is enclosed by melted solder during soldering and generate a different color from that before soldering. The color difference allows the soldering quality of the soldering contact to be determined by visual inspection and prevents inferior products from entering subsequent fabrication processes, thereby improving the soldering reliability.

* * * * *